

Ordering Information

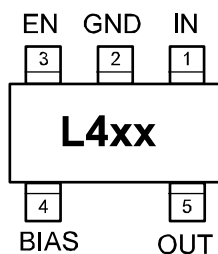
Part Number				Voltage**	Junction Temp. Range	Package
Standard	Marking Code	Pb-Free	Marking Code*			
MIC5238-1.0BM5	L410	MIC5238-1.0YM5	<u>L</u> 410	1.0V	−40° to +125°C	SOT-23-5
MIC5238-1.1BM5	L411	MIC5238-1.1YM5	<u>L</u> 411	1.1V	−40° to +125°C	SOT-23-5
MIC5238-1.3BM5	L413	MIC5238-1.3YM5	<u>L</u> 413	1.3V	−40° to +125°C	SOT-23-5
MIC5238-1.0BD5	N410	MIC5238-1.0YD5	<u>N</u> 410	1.0V	−40° to +125°C	TSOT-23-5
MIC5238-1.1BD5	N411	MIC5238-1.1YD5	<u>N</u> 411	1.1V	−40° to +125°C	TSOT-23-5
MIC5238-1.3BD5	N413	MIC5238-1.3YD5	<u>N</u> 413	1.3V	−40° to +125°C	TSOT-23-5

Notes:

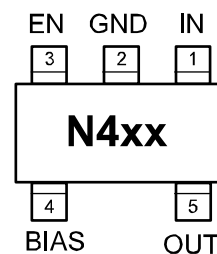
* Under bar symbol () may not be to scale.

** Other voltage options available. Contact Micrel Marketing for details.

Pin Configuration



5-Pin SOT-23 (M5)



5-Pin Thin SOT-23 (D5)

Pin Description

Pin Number	Pin Name	Pin Function
1	IN	Supply Input
2	GND	Ground
3	EN	Enable (Input): Logic Low = shutdown; Logic High = enable. Don not leave open.
4	BIAS	Bias Supply Input
5	OUT	Regulator Output

Absolute Maximum Ratings⁽¹⁾

Input Supply Voltage (V_{IN})	–0.3V to 7V
BIAS Supply Voltage (V_{BIAS})	–0.3V to 7V
Enable Supply Voltage (V_{EN})	–0.3V to 7V
Power Dissipation (P_D)	Internally Limited
Junction Temperature (T_J)	–40°C to +125°C
Storage Temperature (T_S)	–65°C to +150°C
ESD Rating ⁽³⁾	1.5 μ A HBM

Operating Ratings⁽²⁾

Supply Voltage (V_{IN})	1.5V to 6V
BIAS Supply Voltage (V_{BIAS})	2.3V to 6V
Enable Supply Voltage (V_{EN})	0V to 6V
Junction Temperature (T_J)	–40°C to +125°C
Package Thermal Resistance	
SOT-23-5 (θ_{JA})	235°C/W

Electrical Characteristics⁽⁴⁾

$T_A = 25^\circ\text{C}$ with $V_{IN} = V_{OUT} + 1\text{V}$; $V_{BIAS} = 3.3\text{V}$; $I_{OUT} = 100\mu\text{A}$; $V_{EN} = 2\text{V}$, **bold** values indicate $-40^\circ\text{C} < T_J < +125^\circ\text{C}$, unless specified.

Parameter	Condition	Min	Typ	Max	Units
Output Voltage Accuracy	Variation from nominal V_{OUT}	–1.5		+1.5	%
		–2		+2	%
Line Regulation	$V_{BIAS} = 2.3\text{V to } 6\text{V}$, Note 5		0.25	0.5	%
Input Line Regulation	$V_{IN} = (V_{OUT} + 1\text{V}) \text{ to } 6\text{V}$		0.04	4	%
Load Regulation	Load = 100 μ A to 150mA		0.7	1	%
Dropout Voltage	$I_{OUT} = 100\mu\text{A}$		50		mV
	$I_{OUT} = 50\text{mA}$		230	300	mV
				400	mV
	$I_{OUT} = 100\text{mA}$		270		mV
	$I_{OUT} = 150\text{mA}$		310	450	mV
				500	mV
BIAS Current, Note 6	$I_{OUT} = 100\mu\text{A}$		23		μA
Input Current, Pin 1	$I_{OUT} = 100\mu\text{A}$		7	20	μA
	$I_{OUT} = 50\text{mA}$, Note 7		0.35		mA
	$I_{OUT} = 100\text{mA}$		1		mA
	$I_{OUT} = 150\text{mA}$		2	2.5	mA
Ground Current in Shutdown	$V_{EN} \leq 0.2\text{V}$, $V_{IN} = 6\text{V}$, $V_{BIAS} = 6\text{V}$		1.5	5	μA
	$V_{EN} = 0\text{V}$, $V_{IN} = 6\text{V}$, $V_{BIAS} = 6\text{V}$		0.5		μA
Short Circuit Current	$V_{OUT} = 0\text{V}$		350	500	mA
Reverse Leakage	$V_{IN} = 0\text{V}$, $V_{EN} = 0\text{V}$, $V_{OUT} = \text{nom } V_{OUT}$		5		μA

Electrical Characteristics⁽⁴⁾ cont.

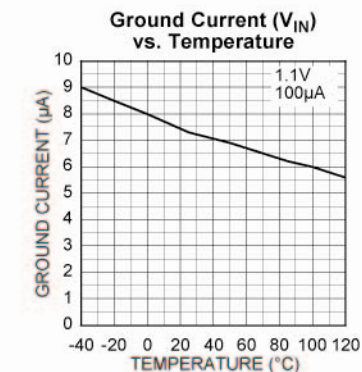
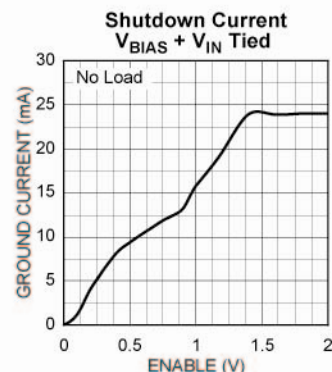
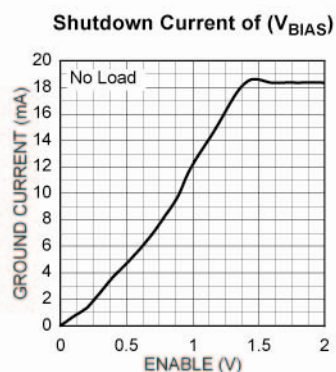
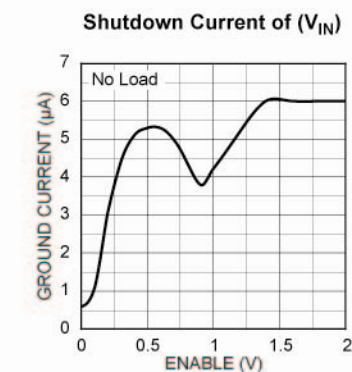
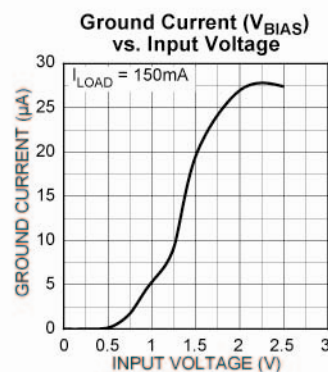
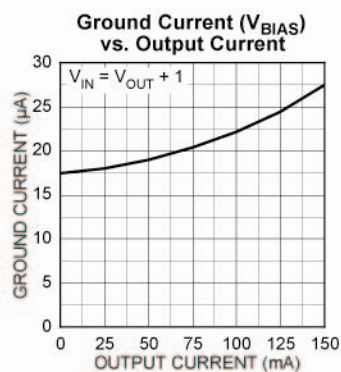
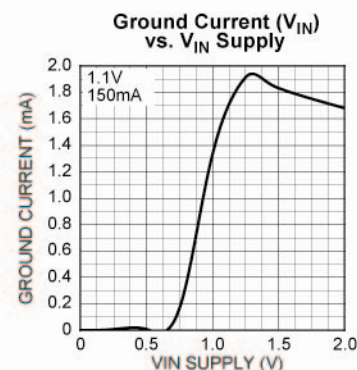
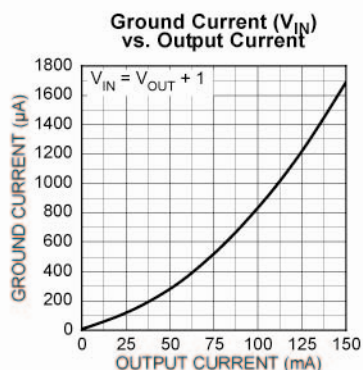
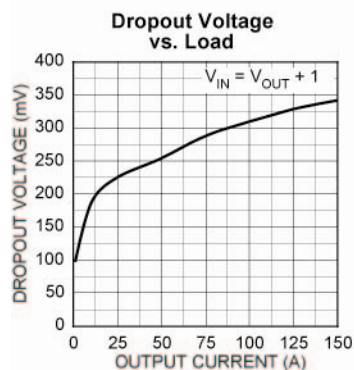
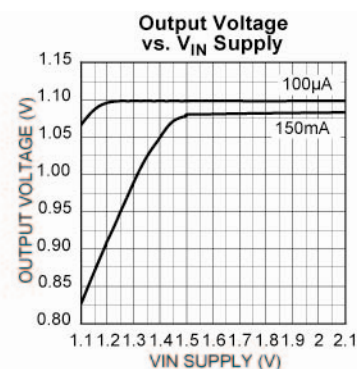
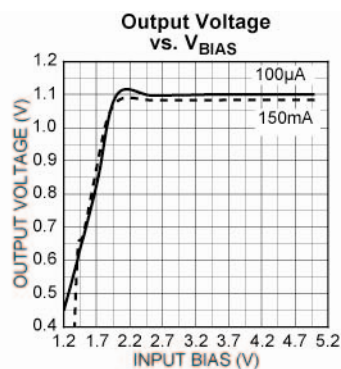
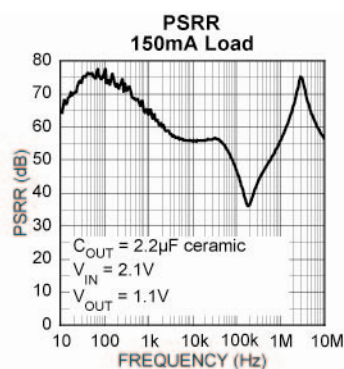
$T_A = 25^\circ\text{C}$ with $V_{IN} = V_{OUT} + 1\text{V}$; $V_{BIAS} = 3.3\text{V}$; $I_{OUT} = 100\mu\text{A}$; $V_{EN} = 2\text{V}$, **bold** values indicate $-40^\circ\text{C} < T_J < +125^\circ\text{C}$, unless specified.

Parameter	Condition	Min	Typ	Max	Units
Enable Input					
Input Low Voltage	Regulator OFF			0.2	V
Input High Voltage	Regulator ON	2.0			V
Enable Input Current	$V_{EN} = 0.2\text{V}$, Regulator OFF	-1.0	0.01	1.0	μA
	$V_{EN} = 0.2\text{V}$, Regulator ON		0.1	1.0	μA

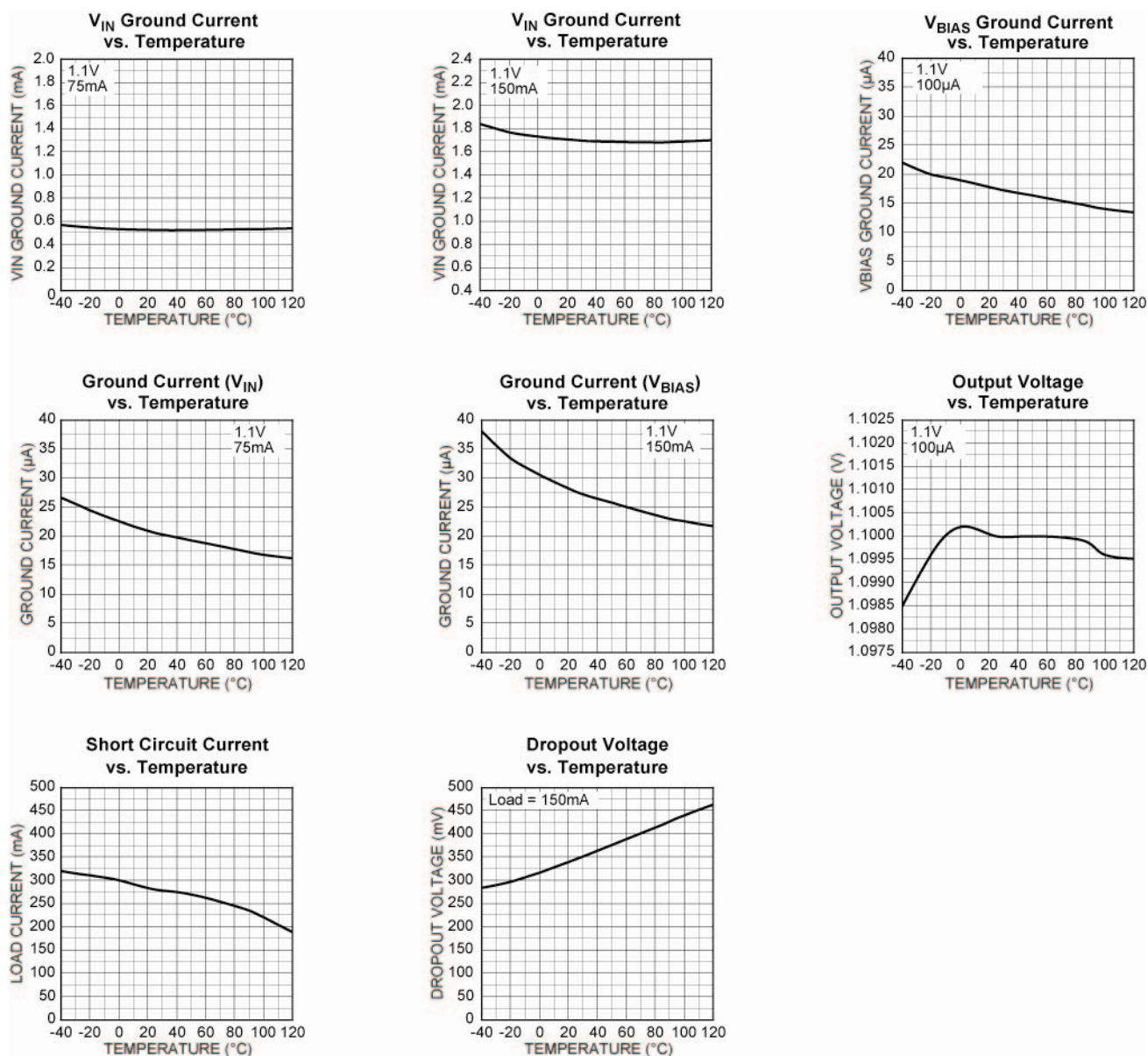
Notes:

1. Exceeding the absolute maximum rating may damage the device.
2. The device is not guaranteed to function outside its operating rating.
3. Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100pF.
4. Specification for packaged product only.
5. Line regulation measures a change in output voltage due to a change in the bias voltage.
6. Current measured from bias input to ground.
7. Current differential between output current and main input current at rated load current.

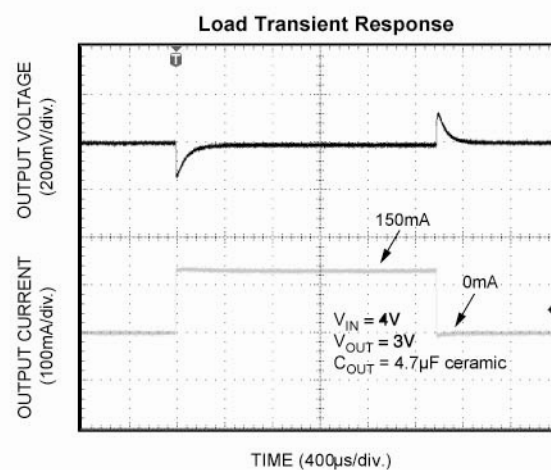
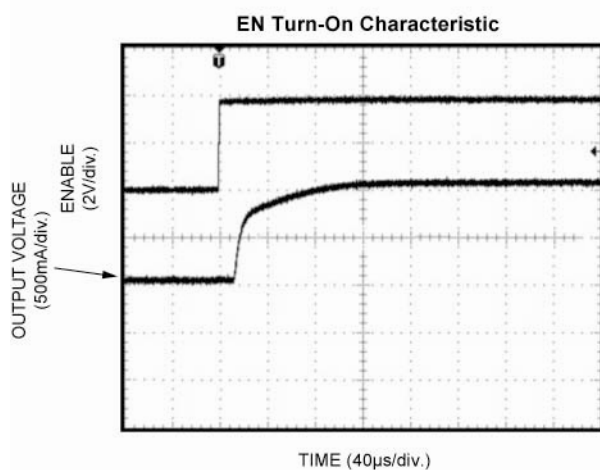
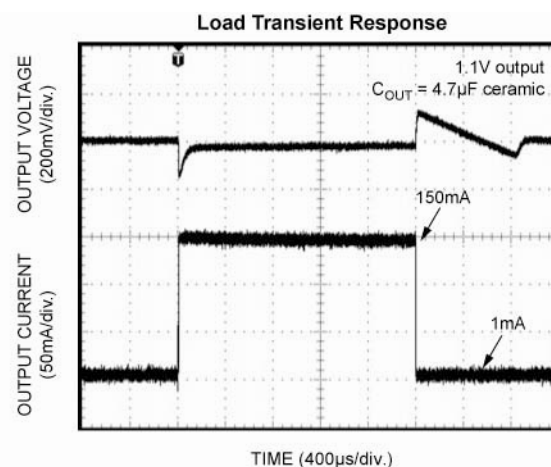
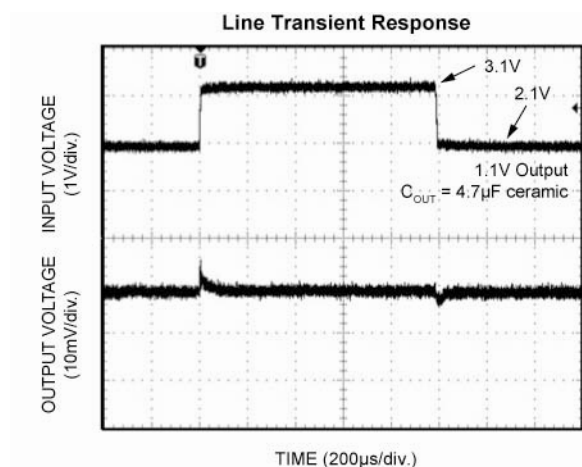
Typical Characteristics



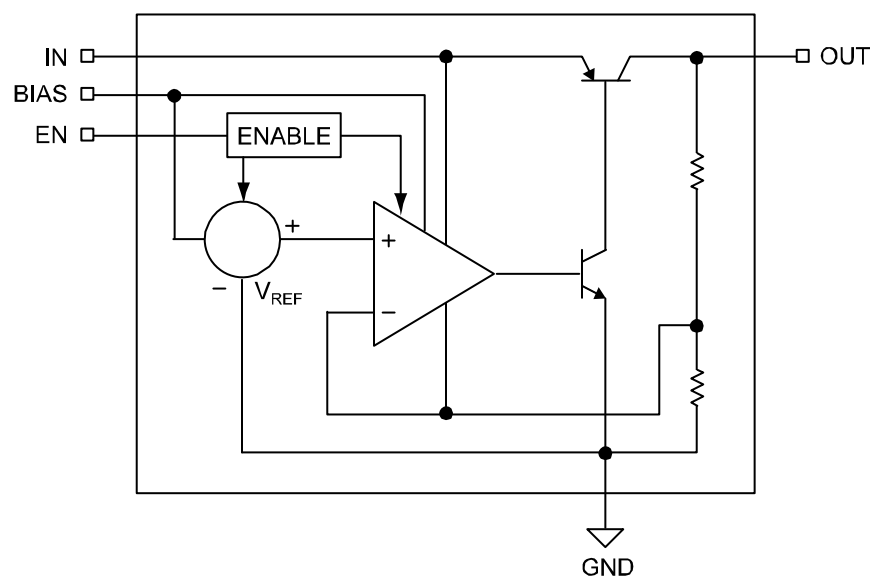
Typical Characteristics cont.



Functional Characteristics



Functional Diagram



Block Diagram – Fixed Output Voltage

Application Information

Enable/Shutdown

The MIC5238 comes with an active-high enable pin that allows the regulator to be disabled. Forcing the enable pin low disables the regulator and sends it into a “zero” off-mode-current state. In this state, current consumed by the regulator goes nearly to zero. Forcing the enable pin high enables the output voltage.

Input Bias Capacitor

The input capacitor must be rated to sustain voltages that may be used on the input. An input capacitor may be required when the device is not near the source power supply or when supplied by a battery. Small, surface mount, ceramic capacitors can be used for bypassing. Larger values may be required if the source supply has high ripple.

Output Capacitor

The MIC5238 requires an output capacitor for stability. The design requires 2.2μF or greater on the output to maintain stability. The design is optimized for use with low-ESR ceramic chip capacitors. High ESR capacitors may cause high frequency oscillation. The maximum recommended ESR is 3Ω. The output capacitor can be increased without limit. Larger valued capacitors help to improve transient response.

X7R/X5R dielectric-type ceramic capacitors are recommended because of their temperature performance. X7R-type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change value by as much as 50% and 60% respectively over their operating temperature ranges. To use a ceramic chip capacitor with Y5V dielectric, the value must be much higher than a X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

No-Load Stability

The MIC5238 will remain stable and in regulation with no load unlike many other voltage regulators. This is especially important in CMOS RAM keep-alive applications.

Thermal Considerations

The MIC5238 is designed to provide 150mA of continuous current in a very small package. Maximum power dissipation can be calculated based on the output current and the voltage drop across the part. To determine the maximum power dissipation of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation:

$$P_{D(MAX)} = \frac{T_{J(max)} - T_A}{\theta_{JA}}$$

$T_{J(MAX)}$ is the maximum junction temperature of the die, 125°C, and T_A is the ambient operating temperature. θ_{JA} is layout dependent; Table 1 shows the junction-to-ambient thermal resistance for the MIC5238.

Package	θ_{JA} Recommended Minimum Footprint
SOT-23-5	235°C/W

Table 1. SOT-23-5 Thermal Resistance

The actual power dissipation of the regulator circuit can be determined using the equation:

$$P_D = (V_{IN} - V_{OUT}) I_{OUT} + V_{IN} I_{GND}$$

Substituting $P_{D(MAX)}$ for P_D and solving for the operating conditions that are critical to the application will give the maximum operating conditions for the regulator circuit. For example, when operating the MIC5238-1.0BM5 at 50°C with a minimum footprint layout, the maximum input voltage for a set output current can be determined as follows.

$$P_{D(MAX)} = \frac{125^\circ\text{C} - 50^\circ\text{C}}{235^\circ\text{C/W}}$$

$$P_{D(MAX)} = 319\text{mW}$$

The junction-to-ambient (θ_{JA}) thermal resistance for the minimum footprint is 235°C/W, from Table 1. It is important that the maximum power dissipation not be exceeded to ensure proper operation. With very high input-to-output voltage differentials, the output current is limited by the total power dissipation. Total power dissipation is calculated using the following equation:

$$P_D = (V_{IN} - V_{OUT}) I_{OUT} + V_{IN} \times I_{GND} + V_{BIAS} \times I_{BIAS}$$

Since the bias supply draws only 18μA, that contribution can be ignored for this calculation.

If we know the maximum load current, we can solve for the maximum input voltage using the maximum power dissipation calculated for a 50°C ambient, 319mW.

$$P_{D(MAX)} = (V_{IN} - V_{OUT}) I_{OUT} + V_{IN} \times I_{GND}$$

$$319\text{mW} = (V_{IN} - 1\text{V}) 150\text{mA} + V_{IN} \times 2.8\text{mA}$$

Ground pin current is estimated using the typical characteristics of the device.

$$469\text{mW} = V_{IN} (152.8\text{mA})$$

$$V_{IN} = 3.07\text{V}$$

For higher current outputs only a lower input voltage will work for higher ambient temperatures.

Assuming a lower output current of 20mA, the maximum input voltage can be recalculated:

$$319\text{mW} = (V_{IN} - 1\text{V}) 20\text{mA} + V_{IN} \times 0.2\text{mA}$$

$$339\text{mW} = V_{IN} \times 20.2\text{mA}$$

$$V_{IN} = 16.8\text{V}$$

Maximum input voltage for a 20mA load current at 50°C ambient temperature is 16.8V. Since the device has a 6V rating, it will operate over the whole input range.

Dual Supply Mode Efficiency

By utilizing a bias supply the conversion efficiency can be greatly enhanced. This can be realized as the higher bias supply will only consume a few μA 's while the input supply will require a few mA's. This equates to higher efficiency saving valuable power in the system. As an example, consider an output voltage of 1V with an input supply of 2.5V at a load current of 150mA. The input ground current under these conditions is 2mA, while the bias current is only 20 μA . If we calculate the conversion efficiency using the single supply approach, it is as follows:

Input power = $V_{\text{IN}} \times \text{output current} + V_{\text{IN}} \times (V_{\text{BIAS}} \text{ ground current} + V_{\text{IN}} \text{ ground current})$

Input power = $2.5\text{V} \times 150\text{mA} + 2.5 \times (0.0002 + 0.002) = 380.5\text{mW}$

Output power = $1\text{V} \times 0.15 = 150\text{mW}$

Efficiency = $150/380.5 \times 100 = 39.4\%$

Now, using a lower input supply of 1.5V, and powering the bias voltage only from the 2.5V input, the efficiency is as follows:

Input power = $V_{\text{IN}} \times \text{output current} + V_{\text{IN}} \times V_{\text{IN}} \text{ ground current} + V_{\text{BIAS}} \times V_{\text{BIAS}} \text{ ground current}$

Input power = $1.5 \times 150\text{mA} + 1.5 \times 0.002 + 2.5 \times 0.0002 = 225\text{mW}$

Output power = $1\text{V} \times 150\text{mA} = 150\text{mW}$

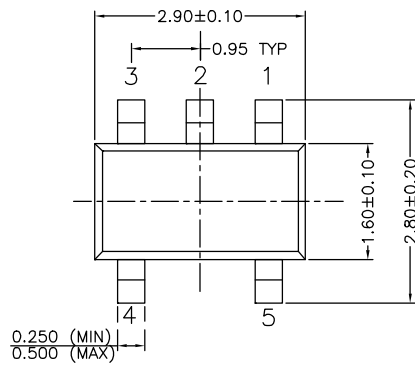
Efficiency = $150/225 \times 100 = 66.6\%$

Therefore, by using the dual supply MIC5238 LDO the efficiency is nearly doubled over the single supply version.

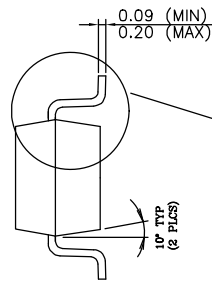
This is a valuable asset in portable power management applications equating to longer battery life and less heat being generated in the application.

This in turn will allow a smaller footprint design and an extended operating life.

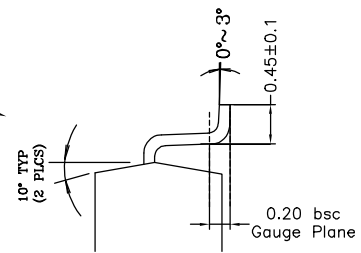
Package Information



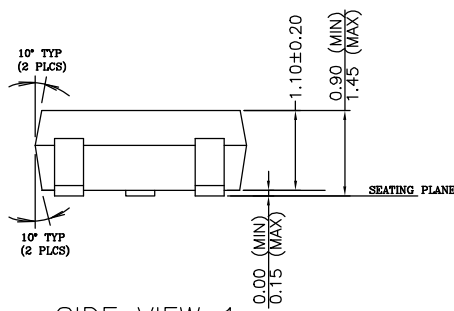
TOP VIEW



END VIEW



DETAIL



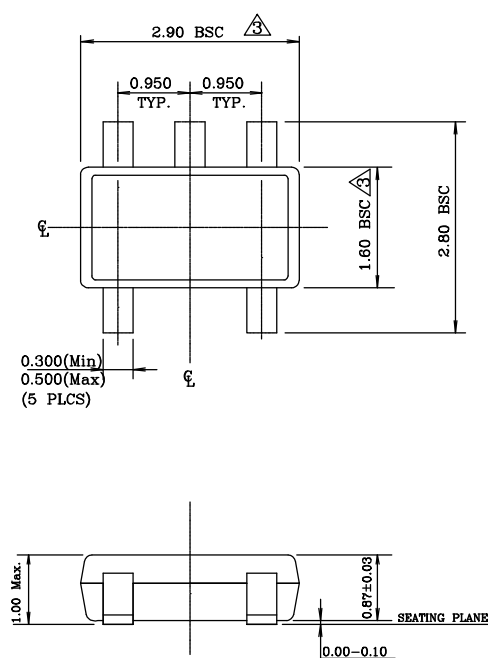
SIDE VIEW 1

NOTE:

1. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASH & BURR.
2. PACKAGE OUTLINE INCLUSIVE OF SOLER PLATING.
3. DIMENSION AND TOLERANCE PER ANSI Y14.5M, 1982.
4. FOOT LENGTH MEASUREMENT BASED ON GAUGE PLANE METHOD.
5. DIE FACES UP FOR MOLD, AND FACES DOWN FOR TRIM/FORM.
6. ALL DIMENSIONS ARE IN MILLIMETERS.

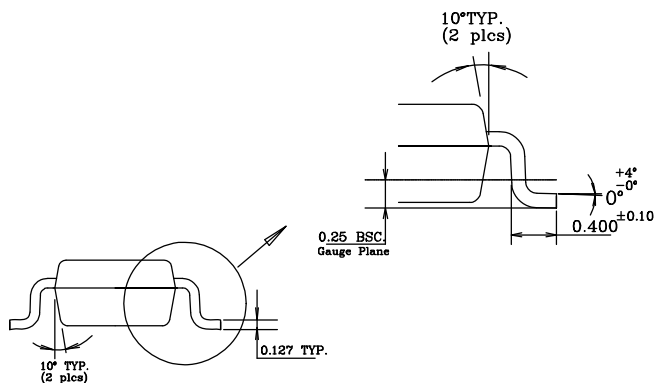
5-Pin SOT-23 (M5)

Package Information cont.



NOTE:

1. Dimensions and tolerances are as per ANSI Y14.5M, 1994.
2. Die is facing up for mold. Die is facing down for trim/form, ie. reverse trim/form.
3. Dimensions are exclusive of mold flash and gate burr.
4. The footlength measuring is based on the gauge plane method.
5. All specification comply to Jedec Spec M0193 Issue C.
6. All dimensions are in millimeters.



5-Pin Thin SOT-23 (D5)

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

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